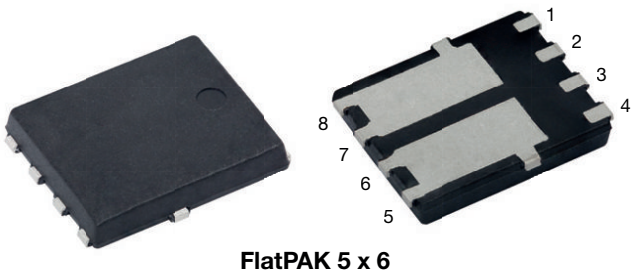
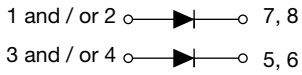
# High Current Density Surface-Mount Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F$ = 0.64 V at $I_F$ = 2 A




**FlatPAK 5 x 6**




## FEATURES

- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE Available

RoHS COMPLIANT

HALOGEN FREE

## LINKS TO ADDITIONAL RESOURCES

3D Models

| PRIMARY CHARACTERISTICS | |
|---|---|
| $I_{F(AV)}$ | 2 x 4 A |
| $V_{RRM}$ | 200 V |
| $I_{FSM}$ | 60 A |
| $V_F$ at $I_F$ = 4 A ($T_J$ = 125 °C) | 0.72 V |
| $T_J$ max. | 150 °C |
| Package | FlatPAK 5 x 6 |
| Circuit configuration | Separated cathode |

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** FlatPAK 5 x 6
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified
("_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ($T_A$ = 25 °C unless otherwise noted) | | | |
|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **V8K202DU** | **UNIT** |
| Device marking code | | V822D | |
| Maximum repetitive peak reverse voltage | $V_{RRM}$ | 200 | V |
| Maximum DC forward current per diode | $I_{F(AV)}$ (1) | 4 | A |
| | $I_{F(AV)}$ (2) | 1.8 | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | $I_{FSM}$ | 60 | A |
| Operating junction temperature range | $T_J$ (3) | -40 to +150 | °C |
| Storage temperature range | $T_{STG}$ | -55 to +150 | °C |

**Notes**

(1) With infinite heatsink
(2) Free air, mounted on recommended pad area
(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

| **ELECTRICAL CHARACTERISTICS** ($T_J$ = 25 °C unless otherwise noted) | | | | | | |
|---|---|---|---|---|---|---|
| **PARAMETER** | **TEST CONDITIONS** | | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Instantaneous forward voltage per diode | $I_F$ = 2 A | $T_J$ = 25 °C | $V_F$ (1) | 0.79 | - | V |
| | $I_F$ = 4 A | | | 0.87 | 0.92 | |
| | $I_F$ = 2 A | $T_J$ = 125 °C | | 0.64 | - | |
| | $I_F$ = 4 A | | | 0.72 | 0.77 | |
| Reverse current per diode | $V_R$ = 160 V | $T_J$ = 25 °C | $I_R$ (2) | 0.0002 | - | mA |
| | | $T_J$ = 125 °C | | 0.2 | - | |
| | $V_R$ = 200 V | $T_J$ = 25 °C | $I_R$ (2) | - | 0.01 | |
| | | $T_J$ = 125 °C | | 0.5 | 3 | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | | $C_J$ | 130 | - | pF |

**Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

| **THERMAL CHARACTERISTICS** ($T_A$ = 25 °C unless otherwise noted) | | | | |
|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Thermal resistance per diode | $R_{\theta JA}$ (1)(2) | 100 | - | °C/W |
| | $R_{\theta JM}$ (3) | 3.5 | 4.5 | |

**Notes**

(1) The heat generated must be less than thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(3) Mounted on infinite heatsink; thermal resistance $R_{\theta JM}$ - junction-to-mount

| **ORDERING INFORMATION** (Example) | | | | |
|---|---|---|---|---|
| **PREFERRED P/N** | **UNIT WEIGHT (g)** | **PREFERRED PACKAGE CODE** | **BASE QUANTITY** | **DELIVERY MODE** |
| V8K202DU-M3/H | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V8K202DU-M3/I | 0.10 | I | 6000 | 13" diameter plastic tape and reel |
| V8K202DUHM3_A/H (1) | 0.10 | H | 1500 | 7" diameter plastic tape and reel |
| V8K202DUHM3_A/I (1) | 0.10 | I | 6000 | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES ($T_A$ = 25 °C unless otherwise noted)

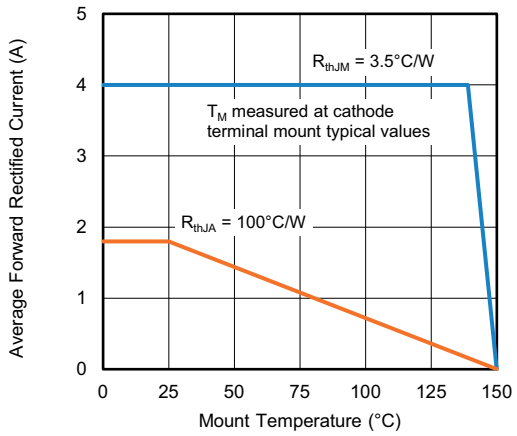



Fig. 1 - Maximum Forward Current Derating Curve

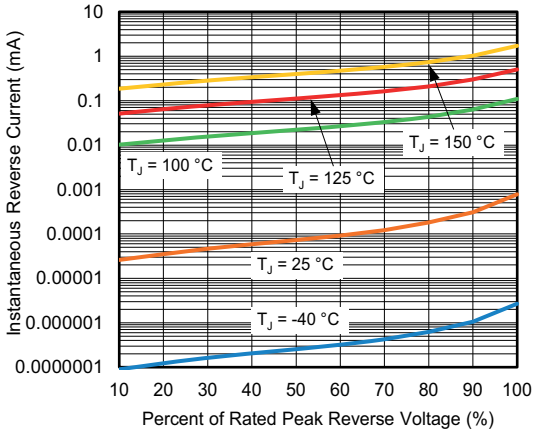



Fig. 4 - Typical Reverse Leakage Characteristics

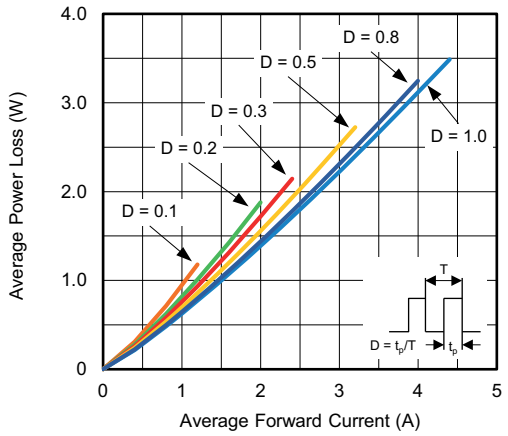



Fig. 2 - Forward Power Loss Characteristics

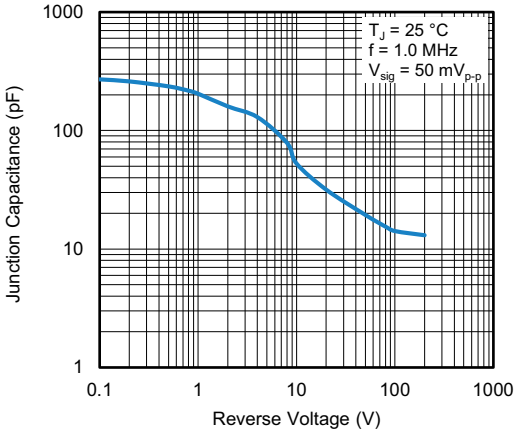



Fig. 5 - Typical Junction Capacitance

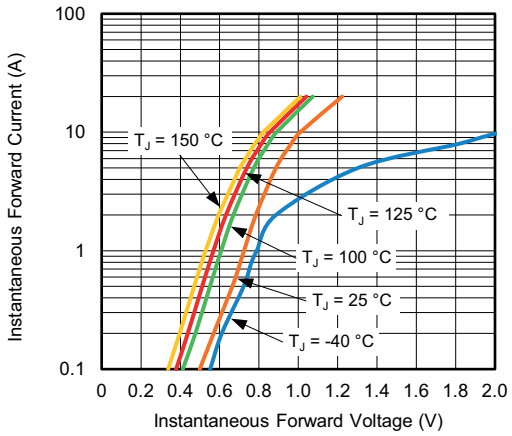



Fig. 3 - Typical Instantaneous Forward Characteristics

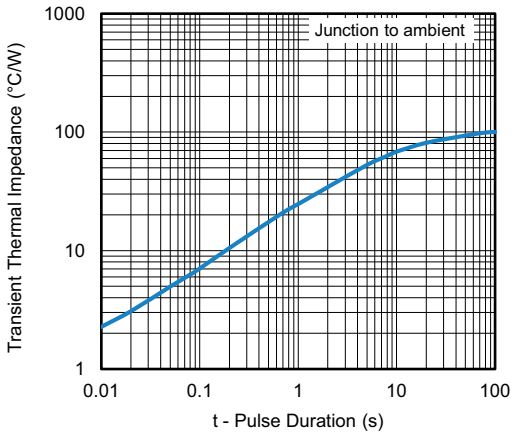
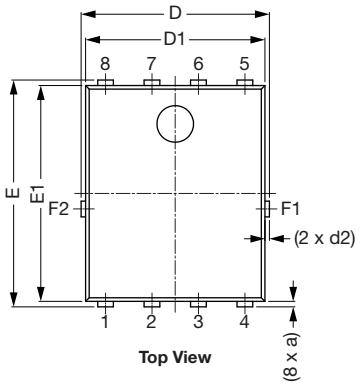
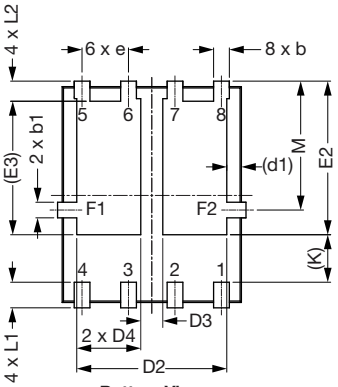



Fig. 6 - Typical Transient Thermal Impedance

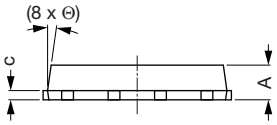
**DIMENSIONS** in inches (millimeters)



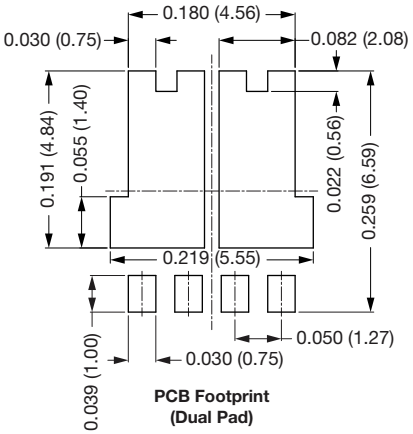

Top View




Bottom View
(Dual Pad)




Side View




PCB Footprint
(Dual Pad)

| DIM. | INCHES | | | MILLIMETERS | | |
|---|---|---|---|---|---|---|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.035 | 0.039 | 0.043 | 0.89 | 0.99 | 1.09 |
| (a) | - | 0.006 | - | - | 0.15 | - |
| b | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| b1 | 0.013 | 0.017 | 0.020 | 0.32 | 0.43 | 0.52 |
| c | 0.008 | - | 0.014 | 0.20 | - | 0.35 |
| D | 0.197 | 0.203 | 0.209 | 5.00 | 5.15 | 5.30 |
| D1 | 0.189 | 0.193 | 0.197 | 4.80 | 4.90 | 5.00 |
| D2 | 0.154 | 0.161 | 0.169 | 3.90 | 4.10 | 4.30 |
| D3 | 0.020 | 0.024 | 0.031 | 0.50 | 0.60 | 0.80 |
| D4 | 0.063 | 0.069 | 0.075 | 1.60 | 1.75 | 1.90 |
| (d1) | - | 0.016 | - | - | 0.40 | - |
| (d2) | - | 0.005 | - | - | 0.125 | - |
| E | 0.238 | 0.244 | 0.250 | 6.05 | 6.20 | 6.35 |
| E1 | 0.228 | 0.232 | 0.236 | 5.80 | 5.90 | 6.00 |
| E2 | 0.157 | 0.165 | 0.173 | 4.00 | 4.20 | 4.40 |
| (E3) | - | 0.144 | - | - | 3.65 | - |
| e | 0.050 BSC | | | 1.27 BSC | | |
| (K) | 0.039 | - | - | 1.00 | - | - |
| L1 | 0.019 | - | 0.043 | 0.48 | - | 1.10 |
| L2 | 0.012 | - | 0.031 | 0.30 | - | 0.80 |
| M | 0.128 | 0.138 | 0.148 | 3.25 | 3.50 | 3.75 |
| Θ | 0° | - | 10° | 0° | - | 10° |

**Notes**

- Dimensioning and tolerancing per ASME Y14.5-2009
- Dimensions D1 and E1 do not include mold flash or gate burrs
- Dimension (XX) means reference only

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